COMPLIANT

HALOGEN

**FREE** 



# Vishay General Semiconductor

## **Surface-Mount Glass Passivated Rectifier**



**SMC (DO-214AB)** 



### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	8.0 A				
$V_{RRM}$	400 V, 600 V, 800 V, 1000 V				
I <sub>FSM</sub>	220 A				
I <sub>R</sub>	10 μA				
$V_F$ at $I_F = 8$ A ( $T_J = 125$ °C)	0.85 V				
T <sub>J</sub> max.	150 °C				
Package	SMC (DO-214AB)				
Circuit configuration	Single				

#### **FEATURES**

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

#### **MECHANICAL DATA**

Case: SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 and M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	S8G	S8J	S8K	S8M	UNIT	
Device marking code		S8G	S8J	S8K	S8M		
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V	
Maximum RMS voltage	V <sub>RMS</sub>	280	420	560	700	V	
Maximum DC blocking voltage	$V_{DC}$	400	600	800	1000	V	
Maximum average forward rectified current	I <sub>F(AV)</sub> (1)	8.0				Α	
Maximum average forward rectified current	I <sub>F(AV)</sub> (2)	1.6				Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	220				А	
Peak forward surge current single half sine-wave at 1.0 ms	I <sub>FSM</sub>	500			Α		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150			°C		

#### Notes

- (1) Mounted on aluminum PCB 30 mm x 30 mm with aluminum heatsink
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	——— T₁= 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.89	-	V
	$I_F = 8.0 A$			0.95	0.975	
	I <sub>F</sub> = 4.0 A	T <sub>J</sub> = 125 °C		0.78	-	
	I <sub>F</sub> = 8.0 A			0.85	0.971	
Reverse current	Rated V <sub>R</sub>	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	10	
	nateu v <sub>R</sub>	T <sub>J</sub> = 125 °C		-	200	μΑ
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	3.6	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	72	ı	pF

#### Notes

(1) Pulse test: 300 μs pulse width; 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	S8G S8J S8K S8M UNIT				
Typical thermal resistance	R <sub>0JA</sub> (1)(2)		°C/W			
Typical thermal resistance	R <sub>0JM</sub> (3)		C/VV			

#### **Notes**

- $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/R_{\theta JA}$
- (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
- (3) Thermal resistance junction-to-mount to follow JEDEC® 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
S8J-E3/I	0.243	I	3500	13" diameter plastic tape and reel			
S8J-M3/I	0.243	I	3500	13" diameter plastic tape and reel			

### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

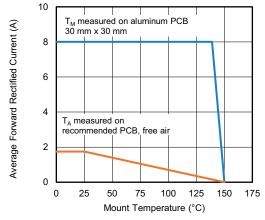


Fig. 1 - Forward Current Derating Curve

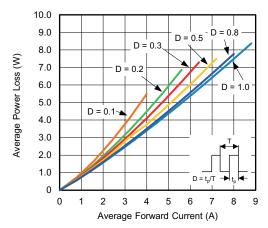


Fig. 2 - Average Power Loss Characteristics



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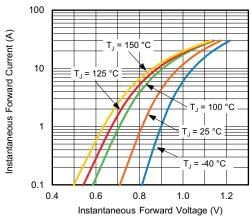


Fig. 3 - Typical Instantaneous Forward Characteristics

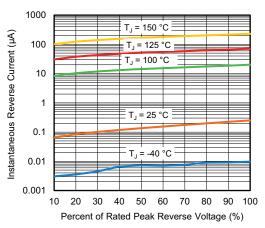


Fig. 4 - Typical Reverse Characteristics

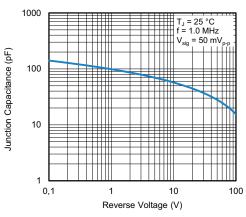


Fig. 5 - Typical Junction Capacitance

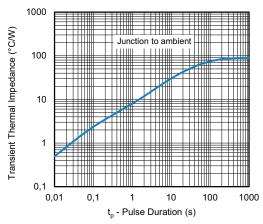
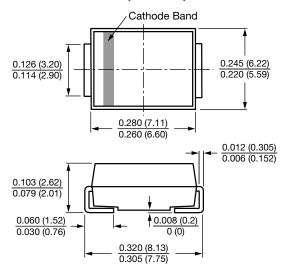


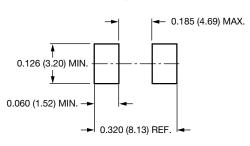
Fig. 6 - Transient Thermal Impedance

# PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### SMC (DO-214AB)



### **Mounting Pad Layout**





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